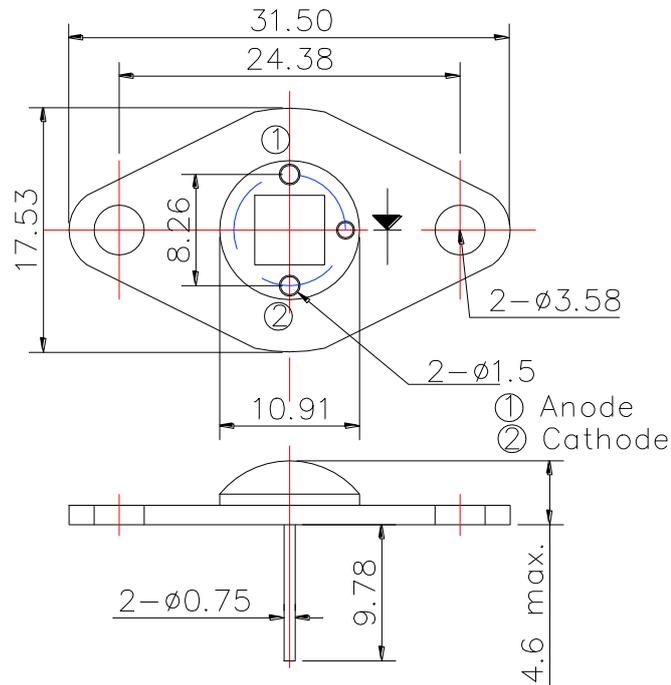


**PRELIMINARY**

# L1300D-66-16100

1300nm High Power TOP LED

## Outline and Internal Circuit



(Unit : mm)

### Features

- Chip Material: InGaAsP
- Chip Dimension: 1000um \* 1000um
- Number of Chips: 16pce
- Peak Wavelength: 1300nm typ.
- Stem: TO-66 stem
- Lens: Silicone and / or Epoxy resin

**Absolute Maximum Ratings (Tc=25°C)**

Item	Symbol	Ratings	Unit
Power Dissipation	PD	(6.8)	W
Forward Current	IF	(4.0)	A
Reverse Voltage	VR	20	V
Thermal Resistance	Rthja	2	K/W
Junction Temperature	Tj	120	°C
Operating Temperature	Topr	-40 ~ +85	°C
Storage Temperature	Tstg	-40 ~ +100	°C
Soldering Temperature	TSOL	265	°C

‡Soldering condition: Soldering condition must be completed with 3 seconds at 265°C.

**Optical and Electrical Characteristics (Tc=25°C)**

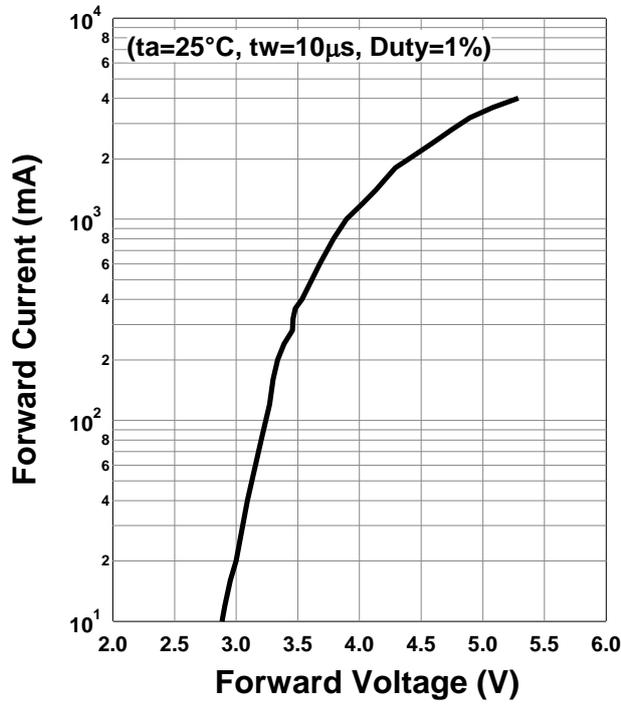
(\*: 100% testing, \*\*: reference value)

Parameter	Symbol	Min	Typ	Max	Unit	Test Condition
Forward Voltage	VF		4.4	(6.0)	V	IF=2A
Total Radiated Power	PO		(1100)		mW	IF=2A
Peak Wavelength	$\lambda_p$	1250		1350	nm	IF=2A
Half Width	$\Delta\lambda$		80		nm	IF=2A
Viewing Half Angle	$\theta_{1/2}$		±61		deg.	IF=100mA
Rise Time	tr		90		ns	IF=2A
Fall Time	tf		30		ns	IF=2A

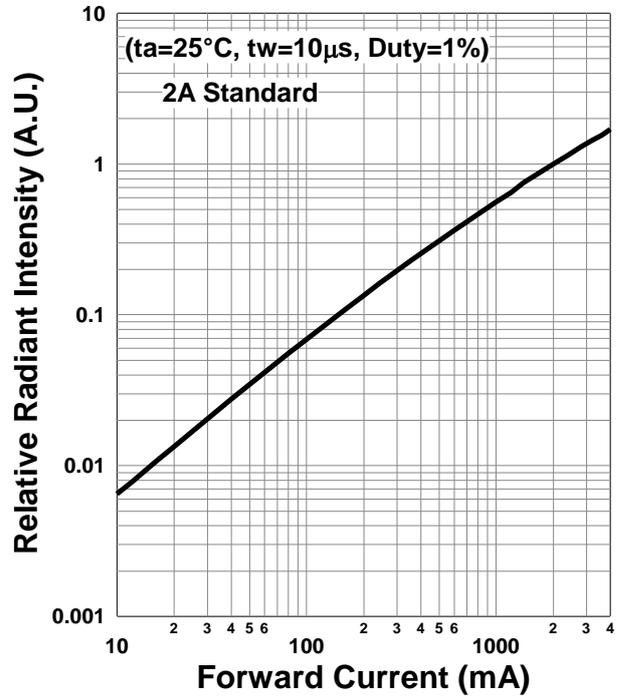
‡ Radiated Power is measured by G8370-85.

**Typical Characteristic Curves**

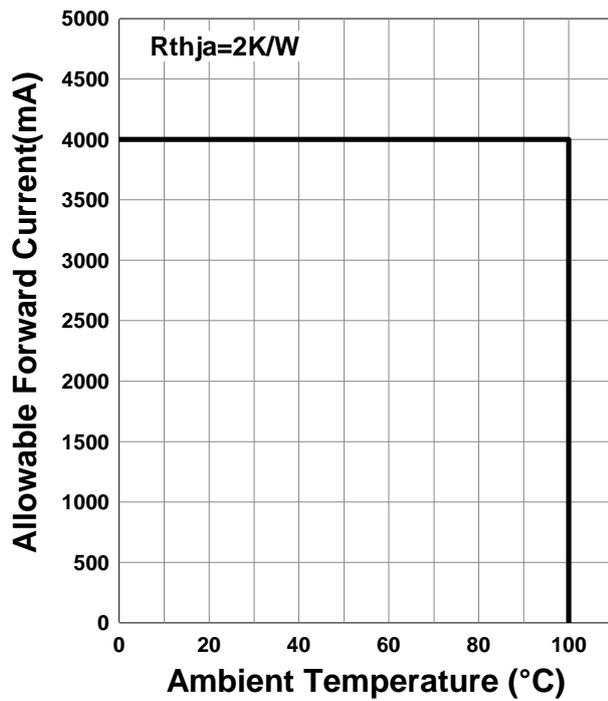
**Forward Current - Forward Voltage**

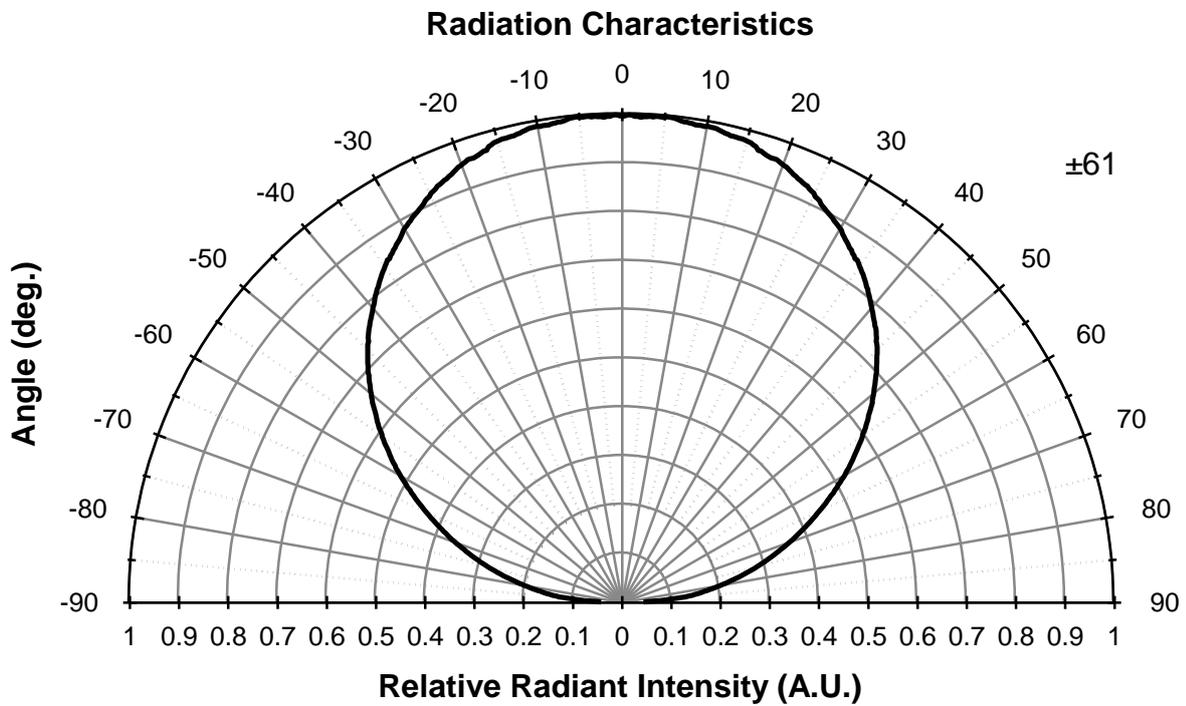
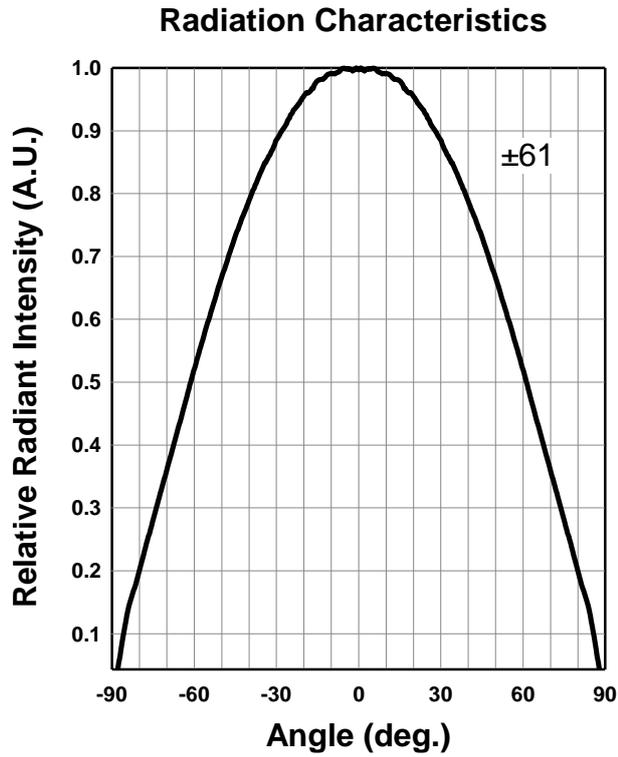


**Relative Radiant Intensity - Forward Current**

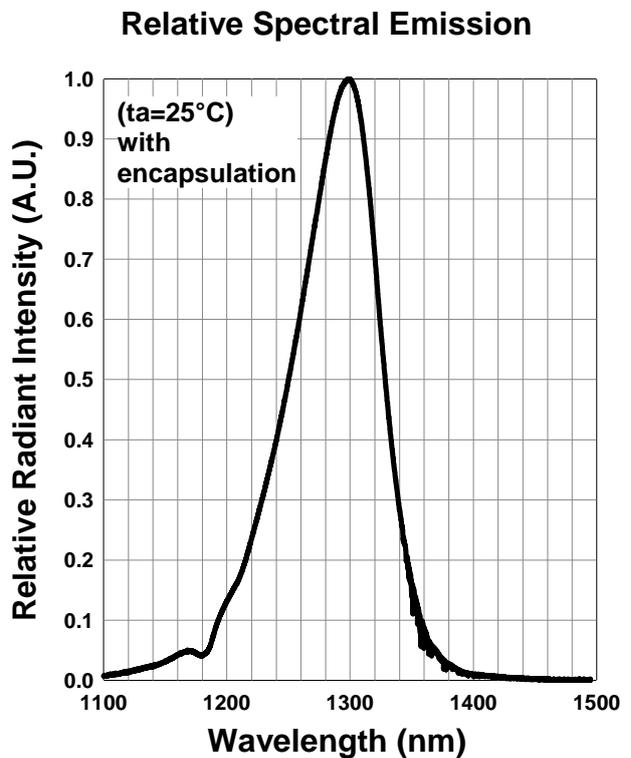
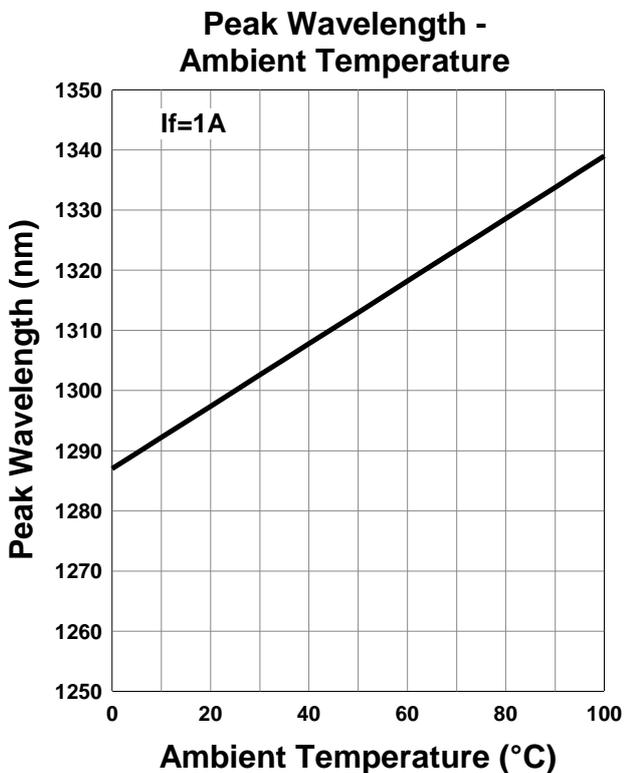
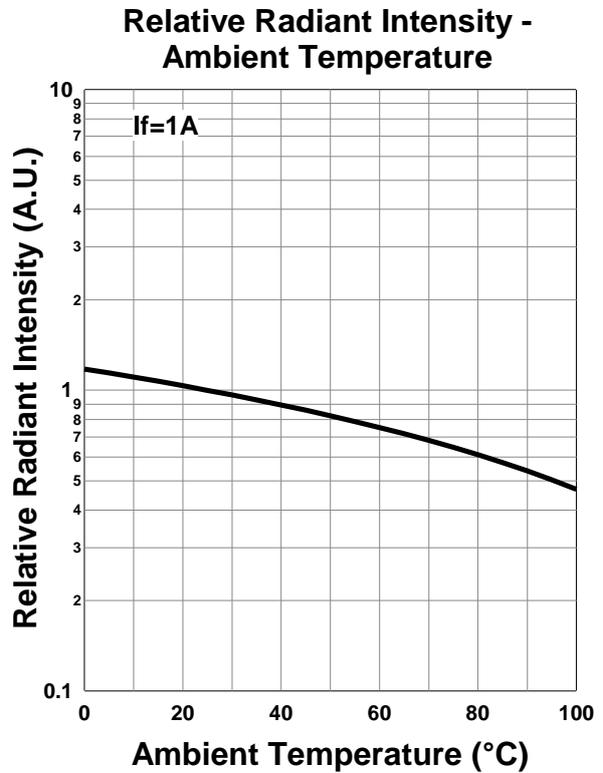
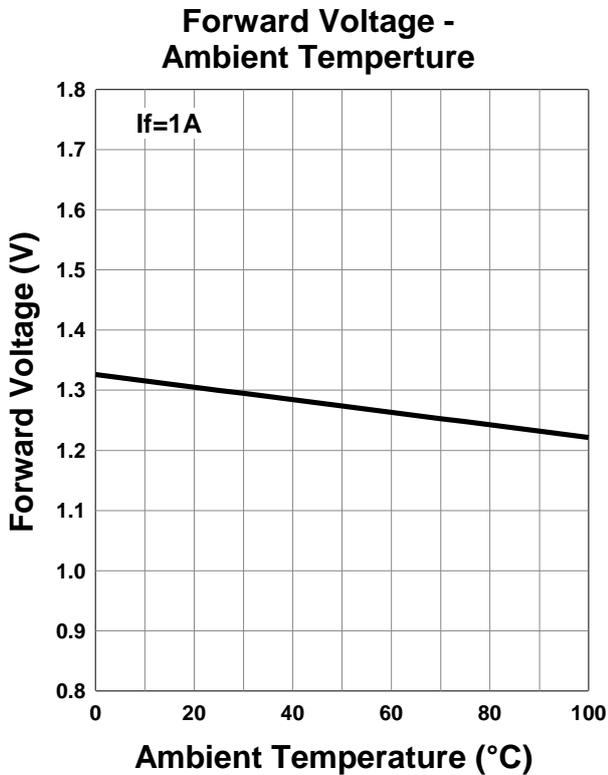


**Allowable Forward Current - Ambient Temperature**





\*The data below shows the characteristics of one representative TO-66 chip.



**Disclaimer**

Product specifications and data shown in this product catalog are subject to change without notice for the purposes of improving product performance, reliability, design, or otherwise.

Product data and parameters in this catalog are typical values based on reasonably up-to-date measurements.

Product data and parameters may vary by user application and over time.

Products shown in this catalog are intended to be used for general electronic equipment. Products are not guaranteed for applications where product malfunction or failure may cause personal injury or death, including but not limited to life-supporting / saving devices, medical devices, safety devices, airplanes, aerospace equipment, automobiles, traffic control systems, and nuclear reactor control systems.